

08-25-05

IFW



Appl. No. 10/803,782

Amdt. dated August 24, 2005

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/803,782
Applicant(s) : Edward G. Combs *et al.*
Filed : March 18, 2004
TC/A.U. : 2814
Examiner : Chambliss, Alonzo
Docket No. : 36080-00802
Customer No. : 27171
Title : *Method of Manufacturing an Enhanced Thermal Dissipation Integrated Circuit Package*

Mail Stop Amendment
COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

This amendment is being submitted after allowance of the application to amend the first sentence of the application to include a benefit claim.

Amendments to the Specification are on page 2 of this paper.

Remarks begin on page 3 of this paper.